

# QUALITEK® 350NVOC/ 350NVOCFNO CLEAN FLUX

CORPORATE HEADQUARTERS USA: 315 Fairbank St. Addison, IL \*630-628-8083 \* FAX 630-628-6543

EUROPE UK: Unit 9 Apex Ct. Bassendale Rd. Bromborough, Wirral CH62 3RE \* 44 151 334 0888 \* FAX 44 151 346 1408

ASIA-PACIFIC HEADQUARTERS SINGAPORE: 6 Tuas South St. 5 Singapore 637790 \* 65 6795 7757 \* FAX 65 6795 7767

PHILIPPINES: Phase 1 Qualitek Ave. Mariveles, Bataan Philippines C-2106 \* 6347 935 4163 \* FAX 63475613717

CHINA: 3B/F, YiPa Print Bldg. 351 # JiHua Rd., Buji Shenzhen, China 518112 \* 86 755 28522814 \* FAX 86 755 28522787

## **Description**

Qualitek® 350NVOC/NVOCF is a halide-free, VOC-free flux designed for wave soldering, surface mount board assembly and through-hole applications. Qualitek 350NVOC is a water-based, non-flammable flux designed to improve soldering performance. 350NVOC is intended for spray applications, whereas 350NVOCF may be used for foaming applications.

#### Main Features

- VOC-Free formulation
- □ Excellent solderability
- □ Halide-Free
- □ Spray or foaming types available
- □ Compatible with Lead-Free & Leaded Solder Systems

#### **Technical Data**

| 10011110ai Bata                       |                           |                    |                    |  |
|---------------------------------------|---------------------------|--------------------|--------------------|--|
|                                       | Specification             |                    | Test Method        |  |
| Flux Classification                   | ORL0                      |                    | IPC-J-STD-004B     |  |
| Color and Appearance                  | Light Straw Liquid        |                    |                    |  |
| Copper Mirror                         | Pass                      |                    | IPC-TM-650 2.3.32  |  |
| SIR                                   | >1 x 10 <sup>8</sup> ohms |                    | IPC-TM-650 2.6.3.3 |  |
| Specific Gravity (g/cm <sup>3</sup> ) | 1.01 ± 0.01 (Spray)       | 0.96 ± 0.05 (Foam) |                    |  |
| Solids                                | 4.1 – 4.5 (Spray)         | 1.3 – 2.3 (Foam)   |                    |  |
| Acid Number (mgKOH/g)                 | 18.0 – 22.0               | , ,                | Titration          |  |

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#### Flux Application

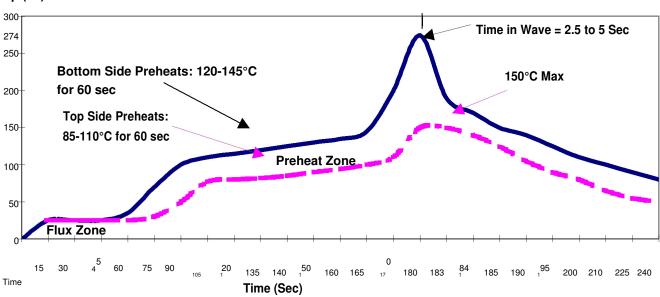
For mass wave soldering of OSP and plated circuit boards, spray, foam or wave fluxing can be utilized to apply this flux. Flux deposition density and uniformity are critical to successful use of low solids no-clean flux. If foam fluxing, the foam fluxer should be supplied with compressed air, which is free of oil and water. The flux tank should be full at all times. The surface of the flux should be 1-½ inches above the top of the flux aerator, or flux stone. Pressure should then be adjusted to produce the optimum foam height with a fine uniform foam head. After fluxing, an air knife should be used to remove excessive flux from the assembly.

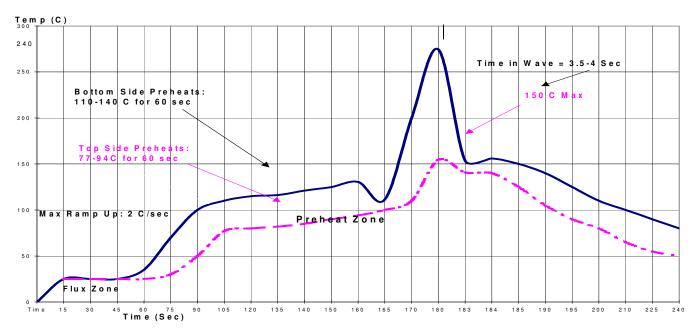
The uniformity of the coating can be visually checked by running a tempered glass plate (usually available through the machine manufacturer) through the spray and preheat sections, and inspected before going across the wave.

| OPERATING PARAMETERS                                 | TYPICAL LEVEL                                   |  |
|--|---|--|
| Amount of flux                                       | Foam, Wave: 1000-2000 μg/in <sup>2</sup> solids |  |
|  | Spray: 750-1500 μg/in <sup>2</sup> solids       |  |
| Foam Fluxing Parameters                              |   |  |
| Foam Stone Pore Size                                 | 20-50 μm  |  |
| Flux Level Above Stone                               | 1-1 ½ inches (25-40mm)                          |  |
| Chimney Opening                                      | 3/8-1/2 inch (10-13 mm)                         |  |
| Air Pressure   | 1-2 psi   |  |
| Top Side Preheat Temperature                         | 190-230 °F (85-110 °C)                          |  |
| Bottom Side Preheat Temperature                      | 65 °F (35 °C) higher than topside               |  |
| Conveyor Speed                                       | 4-6 feet/minute(1.2-1.8 meters/minute)          |  |
| Contact Time in the Solder (including Chip & Lambda) | 2.5-4.5 seconds                                 |  |
| Solder Pot Temperature                               |   |  |
| Sn96.5/Ag3.5   | 500-530 °F (260-276 °C)                         |  |
|  | 536-565 °F (280-296 °C)                         |  |
| Sn99.3/Cu0.7   | 510-530 °F (265-276 °C)                         |  |
| SnAgCu   | 520-530 °F (271-276 °C)                         |  |
| Sn95/Sb5   | 536-565 °F (280-296 °C)                         |  |

#### TYPICAL Lead Free Wave Solder Profile (SNAGCU)

#### Temp (°C)





### TYPICAL Leaded Wave Solder Profile (Sn63/Pb37)

#### **Process Control**

Control of flux during use is necessary to assure consistent flux deposition on the circuit board. Due to the very low solids content of no clean fluxes, specific gravity is not an accurate measure for assessing solids content. Monitoring and controlling acid number by titration is recommended for maintaining the proper flux concentration. Control of the flux can be achieved with deionized water to maintain fluxing activity.

Over time debris and contaminants may accumulate in the flux reservoir. Therefore, periodically replacing the flux and cleaning the reservoir is recommended for consistent performance and minimizing debris build-up.

## **Cleaning**

350NVOC/NVOCF is a no clean formulation; therefore, the residues do not need to be removed for typical applications. If residue removal is desired, the use of Everkleen 1005 Buffered Saponifier with a 5-15% concentration in hot 60 °C (140 °F) will aid in residue removal.

## **Storage & Shelf Life**

350NVOC/NVOCF Liquid Flux should be stored in a 65-80°F environment away from direct heat. Shelf life is 2 years from date of manufacture.

# **Packaging**

350NVOC/NVOCF No Clean Liquid Flux is available in

1 Gallon/1 Liter containers 5 Gallon/5 Liter containers 55 Gallon/20 Liter containers

# **Disposal**

350NVOC/NVOCF contains some hazardous ingredients; therefore, the flux should be disposed of in accordance with federal, state, local & federal authority requirements.

Qualitek® is a brand of Qualitek International, Inc.